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Nb₃Sn Formation Using Electroplating Method for SRF Cavity

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A novel electroplating method to form Nb₃Sn film onto an Nb substrate has been developed and optimized at Fermilab. In this method, a Cu interlayer is plated between an Sn layer and the Nb substrate, then a bronze layer formed in the first step of sequential thermal treatment. Subsequently, the Nb₃Sn layer is formed at 700C by a solid diffusion reaction between the bronze layer and the Nb substrate. In order to advance the research on this method, KEK has started the electroplating for Nb₃Sn formation with the same method but different plating solutions under the US-Japan cooperation. The thermal treatment and characterization of Nb₃Sn samples are performed in the cooperation of NIMS and Tohoku University. Besides, at KEK, remove the excess bronze layer after heat treatment is tried out using several chemical solutions. In this presentation, the result of the Nb₃Sn formation by the electroplating method and the progress on surface treatments to remove the bronze layer are reported.

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